# **74AHC1GU04**

#### Inverter

Rev. 05 — 10 July 2007

**Product data sheet** 

# 1. General description

The 74AHC1GU04 is a high-speed Si-gate CMOS device. It provides an inverting single stage function.

### 2. Features

- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- ESD protection:
  - HBM JESD22-A114E: exceeds 2000 V
     MM JESD22-A115-A: exceeds 200 V
     CDM JESD22-C101C: exceeds 1000 V
- Specified from –40 °C to +125 °C

### 3. Ordering information

#### Table 1. Ordering information

Type number	Package			
	Temperature range Name Description		Description	Version
74AHC1GU04GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AHC1GU04GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753

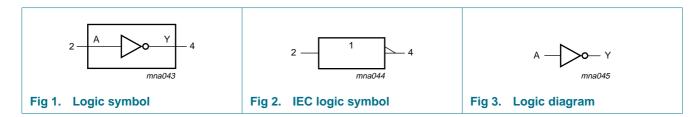
### 4. Marking

#### Table 2. Marking codes

Type number	Marking
74AHC1GU04GW	AD
74AHC1GU04GV	AU4

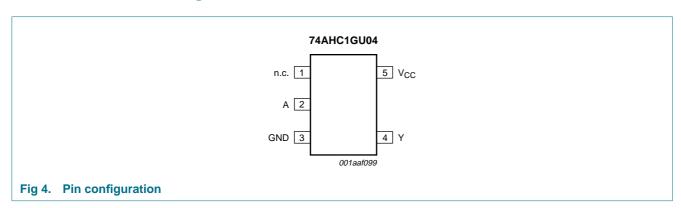


# 5. Functional diagram



# 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
n.c.	1	not connected
A	2	data input
GND	3	ground (0 V)
Υ	4	data output
$V_{CC}$	5	supply voltage

# 7. Functional description

### Table 4. Function table

H = HIGH voltage level; L = LOW voltage level

Input	Output
A	Υ
L	Н
H	L

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V}$	-20	-	mA
VI	input voltage		<u>[1]</u> –0.5	+7.0	V
lok	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	75	mA
$I_{GND}$	ground current		<b>-75</b>	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$	[2] -	250	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC}$ = 3.3 V $\pm$ 0.3 V	-	-	100	ns/V
		$V_{CC}$ = 5.0 V ± 0.5 V	-	-	20	ns/V

### 10. Static characteristics

 Table 7.
 Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions	25 °C -		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>IH</sub> HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.7	-	-	1.7	-	1.7	-	V	
	input voltage	V <sub>CC</sub> = 3.0 V	2.4	-	-	2.4	-	2.4	-	V
		V <sub>CC</sub> = 5.5 V	4.4	-	-	4.4	-	4.4	-	V
$V_{IL}$	LOW-level	$V_{CC} = 2.0V$	-	-	0.3	-	0.3	-	0.3	V
	input voltage	$V_{CC} = 3.0 \text{ V}$	-	-	0.6	-	0.6	-	0.6	V
		$V_{CC} = 5.5 \text{ V}$	-	-	1.1	-	1.1	-	1.1	V

<sup>[2]</sup> For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

**Table 7. Static characteristics** ...continued Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C 1	to +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
$V_{OH}$	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						'		
	output voltage	$I_{O} = -50 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu A; V_{CC} = 3.0 \text{ V}$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$								
		$I_O = 50 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A$ ; $V_{CC} = 4.5 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_{O} = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
II	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	10	-	40	μΑ
C <sub>I</sub>	input capacitance		-	1.5	10	-	10	-	10	pF

# 11. Dynamic characteristics

Table 8. Dynamic characteristics

 $GND = 0 \ V$ ;  $t_f = t_f = \le 3.0 \ \text{ns.}$  For test circuit see Figure 6.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
t <sub>pd</sub>	propagation	A to Y; see Figure 5	<u>[1]</u>								
	delay	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[2]								
		C <sub>L</sub> = 15 pF		-	3.4	7.1	1.0	8.5	1.0	10.0	ns
		$C_L = 50 pF$		-	4.9	10.6	1.0	12.0	1.0	13.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		C <sub>L</sub> = 15 pF		-	2.6	5.5	1.0	6.0	1.0	7.0	ns
		$C_L = 50 pF$		-	3.6	7.0	1.0	8.0	1.0	9.0	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $V_I = GND \text{ to } V_{CC}$	<u>[4]</u>	-	14	-	-	-	-	-	pF

<sup>[1]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

<sup>[2]</sup> Typical values are measured at  $V_{CC} = 3.3 \text{ V}$ .

<sup>[3]</sup> Typical values are measured at  $V_{CC}$  = 5.0 V.

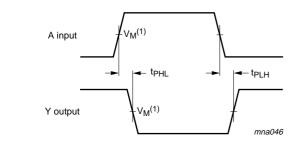
<sup>[4]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$   $f_i = \text{input frequency in MHz;}$ 

 $f_o$  = output frequency in MHz;

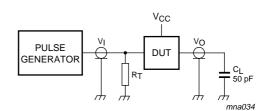
C<sub>L</sub> = output load capacitance in pF;

 $V_{CC}$  = supply voltage in Volts.

### 12. Waveforms



 $V_M = 0.5 \times V_{CC}$ ;  $V_I = GND$  to  $V_{CC}$ .



Test data is given in Table 8.

Definitions for test circuit:

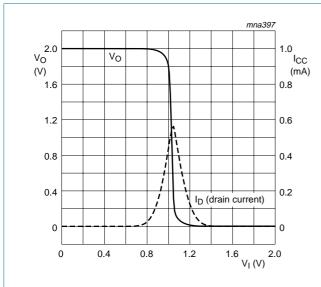
 $C_L$  = Load capacitance including jig and probe capacitance.

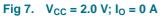
 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

Fig 5. The input (A) to output (Y) propagation delay times

Fig 6. Load circuitry for switching times

# 13. Typical transfer characteristics





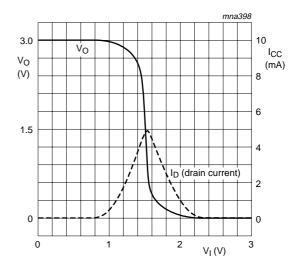
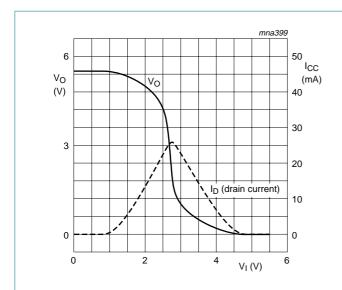


Fig 8.  $V_{CC} = 3.0 \text{ V}; I_O = 0 \text{ A}$ 

6 of 12



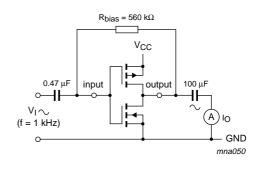


Fig 9.  $V_{CC} = 5.5 \text{ V}$ ;  $I_O = 0 \text{ A}$ 

Fig 10. Test set-up for measuring forward transconductance  $g_{fs} = \Delta I_O / \Delta V_I$  at  $V_O$  is constant

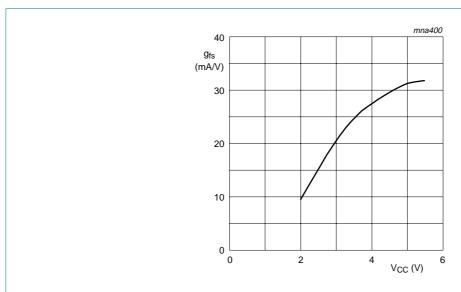


Fig 11. Typical forward transconductance  $g_{fs}$  as a function of the supply voltage at  $T_{amb}$  = 25 °C

# 14. Application information

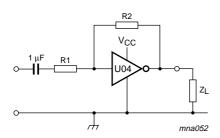
Some applications are:

- Linear amplifier (see Figure 12)
- In crystal oscillator design (see Figure 13)

Remark: All values given are typical unless otherwise specified.

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Maximum  $V_{o(p\text{-}p)}$  =  $V_{CC}-1.5$  V centered at  $0.5\times V_{CC}.$ 

$$G_v = -\frac{G_{ol}}{I + \frac{RI}{R2}(I + G_{ol})}$$

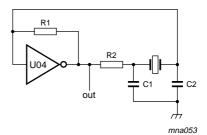
 $G_{ol}$  = open loop gain

G<sub>v</sub> = voltage gain

 $R1 \ge 3 \text{ k}\Omega, R2 \le 1 \text{ M}\Omega$ 

 $Z_L > 10 \text{ k}\Omega; G_{ol} = 20 \text{ (typ.)}$ 

Typical unity gain bandwidth product is 5 MHz.



C1 = 47 pF (typ.)

C2 = 22 pF (typ.)

R1 = 1 M $\Omega$  to 10 M $\Omega$  (typ.)

R2 optimum value depends on the frequency and required stability against changes in  $V_{CC}$  or average minimum  $I_{CC}$  ( $I_{CC}$  is typically 2 mA at  $V_{CC}$  = 3 V and f = 1 MHz).

Fig 12. Used as a linear amplifier

Fig 13. Crystal oscillator configuration

Table 9. External components for resonator (f < 1 MHz)

All values given are typical and must be used as an initial set-up.

Frequency	R1	R2	C1	C2
10 kHz to 15.9 kHz	22 M $\Omega$	220 kΩ	56 pF	20 pF
16 kHz to 24.9 kHz	22 MΩ	220 kΩ	56 pF	10 pF
25 kHz to 54.9 kHz	22 MΩ	100 kΩ	56 pF	10 pF
55 kHz to 129.9 kHz	22 MΩ	100 kΩ	47 pF	5 pF
130 kHz to 199.9 kHz	22 MΩ	47 kΩ	47 pF	5 pF
200 kHz to 349.9 kHz	22 MΩ	47 kΩ	47 pF	5 pF
350 kHz to 600 kHz	22 MΩ	47 kΩ	47 pF	5 pF

Table 10. Optimum value for R2

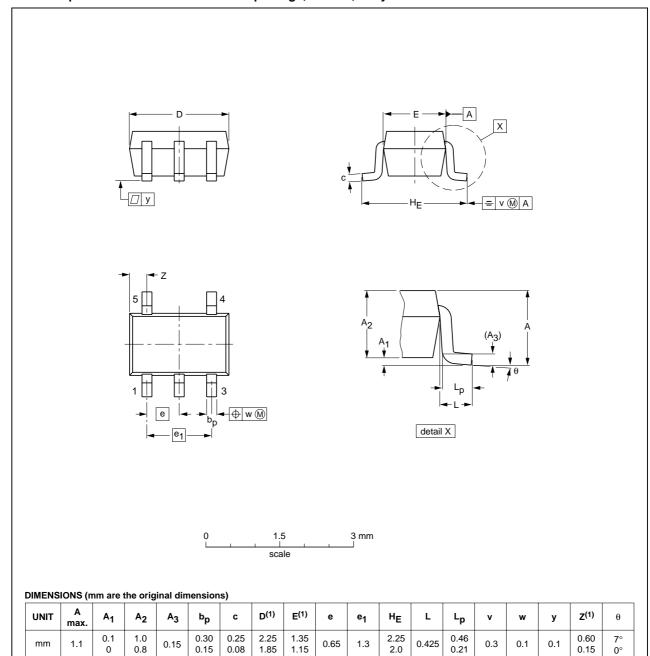
Frequency	R2	Optimum for
3 kHz	$2.0~\text{k}\Omega$	minimum required I <sub>CC</sub>
	$8.0~\mathrm{k}\Omega$	minimum influence due to change in V <sub>CC</sub>
6 kHz	1.0 kΩ	minimum required I <sub>CC</sub>
	$4.7~\mathrm{k}\Omega$	minimum influence by V <sub>CC</sub>
10 kHz	$0.5~\mathrm{k}\Omega$	minimum required I <sub>CC</sub>
	$2.0~\text{k}\Omega$	minimum influence by V <sub>CC</sub>
14 kHz	$0.5~\mathrm{k}\Omega$	minimum required I <sub>CC</sub>
	$1.0~\mathrm{k}\Omega$	minimum influence by V <sub>CC</sub>
>14 kHz	-	replace R2 by C3 with a typical value of 35 pF

8 of 12

# 15. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



**Product data sheet** 

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT353-1		MO-203	SC-88A			<del>-00-09-01</del> 03-02-19	

Fig 14. Package outline SOT353-1 (TSSOP5)

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### Plastic surface-mounted package; 5 leads

**SOT753** 

9 of 12

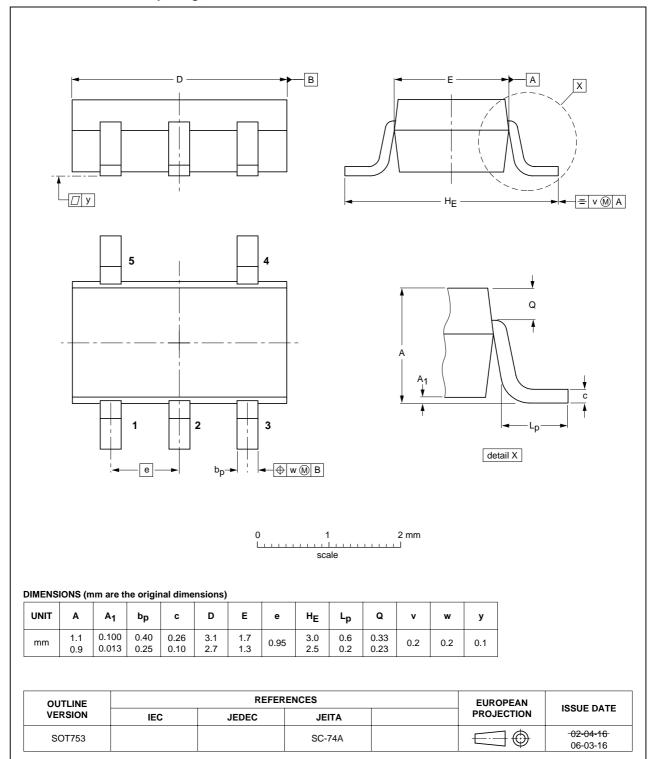


Fig 15. Package outline SOT753 (SC-74A)

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**Product data sheet** 

# 16. Abbreviations

### Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

# 17. Revision history

### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74AHC1GU04_5	20070710	Product data sheet	-	74AHC1GU04_4		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>					
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
	<ul> <li>Package SOT353 changed to SOT353-1 in <u>Section 3</u> and <u>Section 15</u>.</li> </ul>					
	<ul> <li>Quick refer</li> </ul>	ence data and Soldering se	ctions removed.			
74AHC1GU04_4	20020528	Product specification	-	74AHC1GU04_3		
74AHC1GU04_3	20020215	Product specification	-	74AHC1GU04_2		
74AHC1GU04_2	20010427	Product specification	-	74AHC1GU04_1		
74AHC1GU04_1	19990519	Product specification	-	-		

### 18. Legal information

### 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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### 20. Contents

1	General description
2	Features
3	Ordering information
4	Marking 1
5	Functional diagram
6	Pinning information
6.1	Pinning
6.2	Pin description
7	Functional description
8	Limiting values 3
9	Recommended operating conditions 3
10	Static characteristics 3
11	Dynamic characteristics
12	Waveforms
13	Typical transfer characteristics 5
14	Application information 6
15	Package outline 8
16	Abbreviations
17	Revision history
18	Legal information
18.1	Data sheet status
18.2	Definitions
18.3	Disclaimers
18.4	Trademarks11
19	Contact information
20	Contents

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